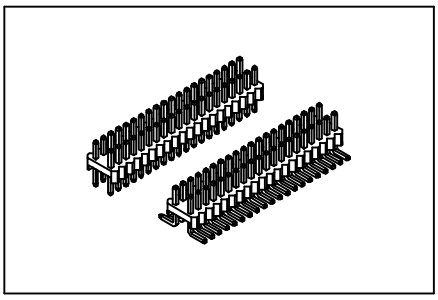
Pin Header 1.27mmX2.54mm(0.050"X0.100")

GXCON



Material:

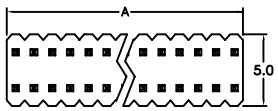
Housing: High temperature housing withstands IR and VPR soldering methods.
Contacts: Brass.
Plating: Gold plated over nickel.
Tin plated over nickel.
Selective gold plated: Gold plated on mating area and tin plated on solder tail.

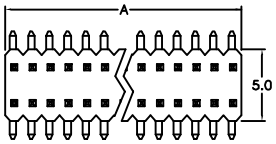
Electrical Characteristics:

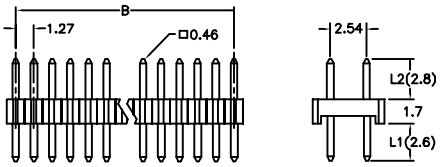
Current Rating: 1 AMP.
Insulator Resistance: 5000MΩmin. at DC 500V.
Contact Resistance: 20mΩmax. at DC 100mA.
Operating Temperature: −65°C~+125°C
Max Processing Temperature: 230°C for 30~60 seconds.

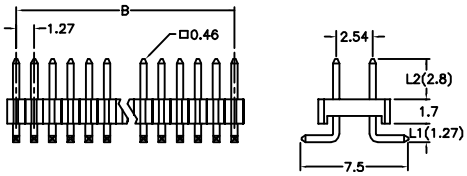
Features:

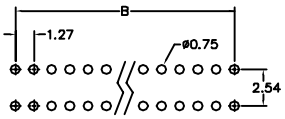
* Choice of through−hole and surface mount.
* Extremely low profile 1.7mm(0.067″).
* Custom design offered.



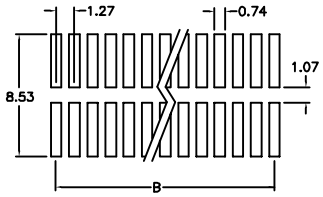








P.C. Board Layout



P.C. Board Layout

Position	6 Thru 100
Dimension	
A	1.27 X No. of Positions /2
B	1.27 X No. of Positions /2−1.27

Ordering information

PH21−	2	50	1	1 /L1 /L2
Series	Double Row	No. of Pin Per Row	3: Selective Gold Plated 1: Gold Plated 2: Tin Plated	1: Straight 3: Surface Mount

Custom Design: Straight (i.e. PH21−25011/L1 /L2)
Surface Mount (i.e. PH21−24013/L1/L2)

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